

PRELIMINARY DATA SHEET

SMP1302-087LF: Surface-Mount PIN Diode

Applications

- Low-loss, high-power switches
- Low-distortion attenuators

Features

- High RF power handling: 125 W
- Low thermal resistance: 22 °C/W
- Low series resistance: 1.5 Ω maximum @ 100 mA
- Low total capacitance: 0.35 pF maximum @ 30 V
- Small QFN (2 x 2 mm) package (MSL1, 260 °C per JEDEC J-STD-020)



Skyworks Green[™] products are compliant with all applicable legislation and are halogen-free. For additional information, refer to *Skyworks Definition of Green*[™], document number SQ04-0074.



Description

The SMP1302-087LF is a surface-mountable, low-capacitance silicon PIN diode designed as a series-connected PIN diode for high-power, high-volume switch and attenuator applications from 10 MHz to beyond 6 GHz.

Maximum resistance at 100 mA is 1.5 Ω and maximum capacitance at 30 V is 0.35 pF. The combination of low capacitance, low parasitic inductance, and nominal 50 μm l-region width, makes the SMP1302-087LF useful in large signal switches and attenuator applications.

The device has a 1 W dissipation power rating, which makes it capable of handling up to 125 W @ 25 °C Continuous Wave (CW) in a series-connected transmit/receive (T/R) switch.

Design information for high power switches may be found in the Skyworks Application Note, *Design With PIN Diodes* (document number 200312).

Table 1. SMP1302-087LF Absolute Maximum Ratings

Parameter	Symbol	Minimum	Maximum	Units
Forward current	lf		200	mA
Reverse voltage	VR		200	V
Dissipated power @ 85 °C	PD		1	W
Peak pulse power dissipation @ 85 $^\circ\mathrm{C}$ (10% duty cycle)			10	W
Operating temperature	Та	-55	+85	°C
Storage temperature	Тѕтс	-55	+200	°C
Junction temperature	TJ	-55	+175	°C
Electrostatic discharge: Charged-Device Model (CDM), Class 4 Human Body Model (HBM), Class 1C Machine Model (MM), Class C	ESD		1100 1000 400	V V V

Note: Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

CAUTION: Although this device is designed to be as robust as possible, Electrostatic Discharge (ESD) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions should be used at all times.

Parameter	Symbol	Test Condition	Min	Typical	Мах	Units
Forward voltage	VF	IF = 10 mA		0.80		V
Reverse leakage current	IR	$V_R = 200 V$			10	μΑ
Series resistance	Rs1	IF = 1 mA, f = 100 MHz		18.0		Ω
	Rs10	$I_F = 10 \text{ mA}, f = 100 \text{ MHz}$		2.75	3.0	Ω
	Rs100	$I_F = 100 \text{ mA}, f = 100 \text{ MHz}$		0.95	1.5	Ω
Total capacitance	Ст30	$V_R=30\;V,f=1\;MHz$		0.25	0.35	pF
Series inductance	Ls			0.65		nH
Minority carrier lifetime	T∟	IF = 10 mA		700		ns
I region width	W			50		μm
Thermal resistance (Note 2)	ΘJC	Junction-to-case		22		°C/W
Peak thermal resistance	ΘΡ	Single, 1 µs pulse width, junction-to-case (10% duty cycle)		2.2		°C/W

Table 2. SMP1302-087LF Electrical Specifications (Note 1) (Ta = +25 $^{\circ}$ C, Unless Otherwise Noted)

Note 1: Performance is guaranteed only under the conditions listed in this Table.

Note 2: Assume a thermal resistance of 90 °C/W for the junction-to-bottom of the circuit board.

Electrical and Mechanical Specifications

The absolute maximum ratings of the SMP1302-087LF are provided in Table 1. Electrical specifications are provided in Tables 2 and 3.

Typical DC performance characteristics of the SMP1302-087LF are illustrated in Figures 1, 2, and 3. Typical RF performance of the SMP1302-087LF using the schematic shown in Figure 4 is summarized in Table 4 and illustrated in Figures 5, 6, and 7.

The SMP1302-087LF Evaluation Board is used to test the performance of the SMP1302-087LF PIN Diode. An assembly drawing for the Evaluation Board is shown in Figure 8. The layer detail physical characteristics are provided in Figure 9. Refer to Table 3 for the Evaluation Board Bill of Materials.

Package Dimensions

The PCB layout footprint for the SMP1302-087LF is provided in Figure 10. Typical case markings are shown in Figure 11.

Typical DC Performance Characteristics

(TA = 25 °C, Unless Otherwise Noted)

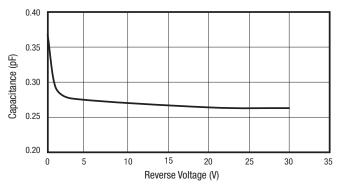


Figure 1. Capacitance vs Reverse Voltage @ 1 MHz

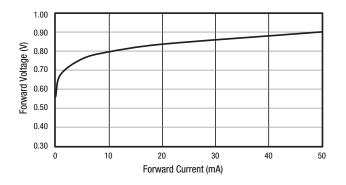


Figure 3. Forward Voltage vs Forward Current

Package dimensions for the SMP1302-087LF are provided in Figure 12, and tape and reel dimensions are provided in Figure 13.

Package and Handling Information

Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The SMP1302-087LF is rated to Moisture Sensitivity Level 1 (MSL1) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *Solder Reflow Information*, document number 200164.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.

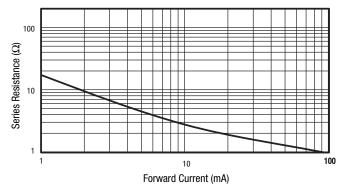


Figure 2. Series Resistance vs Forward Current @ 100 MHz

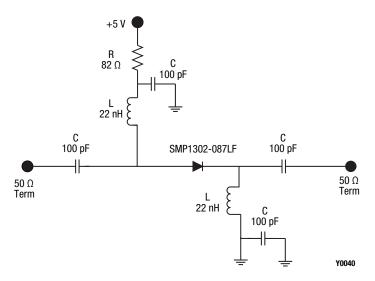


Figure 4. SMP1302-087LF Bias Schematic

Table 3. Evaluation Board Bill of Materials for EN33-D515-01_V3 (Tuned Circuit)

Component	Value	Size	QTY	Manufacturer	Mfg. Part Number	Characteristics
С	100 pF	0402	4	Murata	GRM1555C1H101JZ01	5% COG 50 V
L	22 nH	0402	2	Murata	HK100522NJ-T	5%
R	82 Ω	0402	1	Panasonic	ERJ2GEJ820X	5%, 0.1 W

Table 4. Typical RF Performance @ 25 °C, f = 2.6 GHz

Parameter	Typical	Units			
Un-tuned					
Insertion Loss	0.26	dB			
Return Loss	15.5	dB			
Isolation	-10	dB			
With 22 nH Bias Circuit					
Insertion Loss	0.38	dB			
Return Loss	10.3	dB			
Isolation	-12.6	dB			
Max Power	+47	dBm			

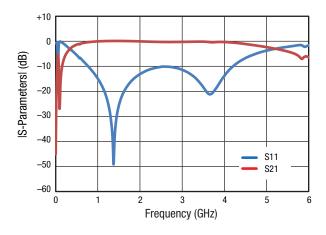


Figure 5. S-Parameter Magnitude vs Frequency If = 50 mA

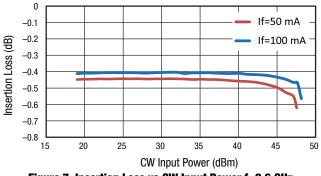


Figure 7. Insertion Loss vs CW Input Power f=2.6 GHz

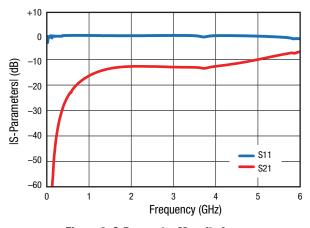


Figure 6. S-Parameter Magnitude vs Frequency VREV = -30 V

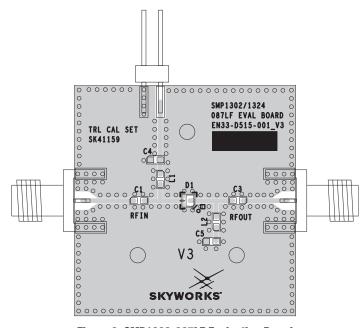
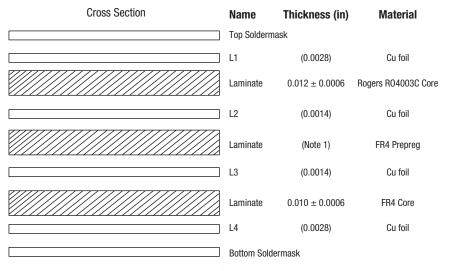


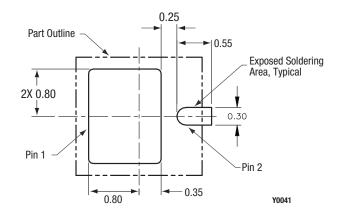
Figure 8. SMP1302-087LF Evaluation Board



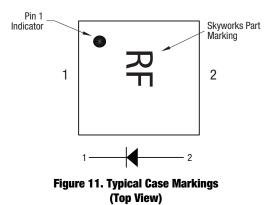
Note 1: Adjust this thickness to meet total thickness goal of 0.062 ± 0.005 inches.

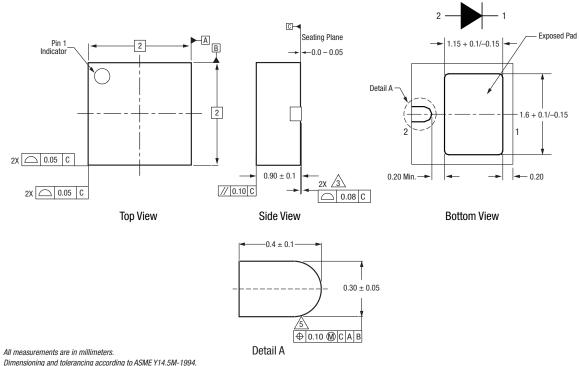
S2531

Figure 9. Board Layer Detail Physical Characteristics







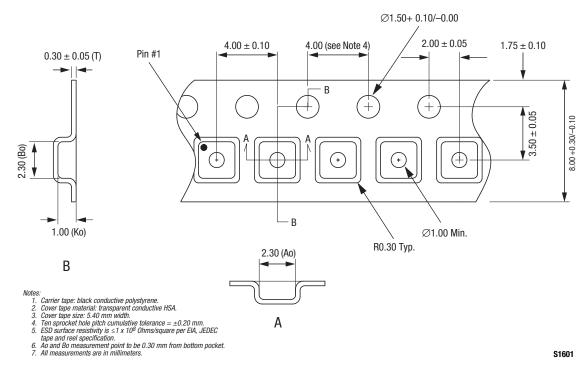


Coplanarity applies to the exposed heat sink slug as well as the terminals...

Dimension applies to metalized terminal and is measured between 0.10 mm and 0.30 mm from terminal tip.

S1989

Figure 12. SMP1302-087LF Package Dimensions





Skyworks Solutions, Inc. • Phone [781] 376-3000 • Fax [781] 376-3100 • sales@skyworksinc.com • www.skyworksinc.com 202942A • Skyworks Proprietary Information • Products and Product Information are Subject to Change Without Notice • August 9, 2013

Ordering Information

Model Name	Manufacturing Part Number	Evaluation Board Part Number
SMP1302-087LF Surface Mount PIN Diode	SMP1302-087LF	SMP1302-087LF EVB

Copyright © 2013 Skyworks Solutions, Inc. All Rights Reserved.

Information in this document is provided in connection with Skyworks Solutions, Inc. ("Skyworks") products or services. These materials, including the information contained herein, are provided by Skyworks as a service to its customers and may be used for informational purposes only by the customer. Skyworks assumes no responsibility for errors or omissions in these materials or the information contained herein. Skyworks may change its documentation, products, services, specifications or product descriptions at any time, without notice. Skyworks makes no commitment to update the materials or information and shall have no responsibility whatsoever for conflicts, incompatibilities, or other difficulties arising from any future changes.

No license, whether express, implied, by estoppel or otherwise, is granted to any intellectual property rights by this document. Skyworks assumes no liability for any materials, products or information provided hereunder, including the sale, distribution, reproduction or use of Skyworks products, information or materials, except as may be provided in Skyworks Terms and Conditions of Sale.

THE MATERIALS, PRODUCTS AND INFORMATION ARE PROVIDED "AS IS" WITHOUT WARRANTY OF ANY KIND, WHETHER EXPRESS, IMPLIED, STATUTORY, OR OTHERWISE, INCLUDING FITNESS FOR A PARTICULAR PURPOSE OR USE, MERCHANTABILITY, PERFORMANCE, QUALITY OR NON-INFRINGEMENT OF ANY INTELLECTUAL PROPERTY RIGHT; ALL SUCH WARRANTIES ARE HEREBY EXPRESSLY DISCLAIMED. SKYWORKS DOES NOT WARRANT THE ACCURACY OR COMPLETENESS OF THE INFORMATION, TEXT, GRAPHICS OR OTHER ITEMS CONTAINED WITHIN THESE MATERIALS. SKYWORKS SHALL NOT BE LIABLE FOR ANY DAMAGES, INCLUDING BUT NOT LIMITED TO ANY SPECIAL, INDIRECT, INCIDENTAL, STATUTORY, OR CONSEQUENTIAL DAMAGES, INCLUDING WITHOUT LIMITATION, LOST REVENUES OR LOST PROFITS THAT MAY RESULT FROM THE USE OF THE MATERIALS OR INFORMATION, WHETHER OR NOT THE RECIPIENT OF MATERIALS HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGE.

Skyworks products are not intended for use in medical, lifesaving or life-sustaining applications, or other equipment in which the failure of the Skyworks products could lead to personal injury, death, physical or environmental damage. Skyworks customers using or selling Skyworks products for use in such applications do so at their own risk and agree to fully indemnify Skyworks for any damages resulting from such improper use or sale.

Customers are responsible for their products and applications using Skyworks products, which may deviate from published specifications as a result of design defects, errors, or operation of products outside of published parameters or design specifications. Customers should include design and operating safeguards to minimize these and other risks. Skyworks assumes no liability for applications assistance, customer product design, or damage to any equipment resulting from the use of Skyworks products outside of stated published specifications or parameters.

Skyworks, the Skyworks symbol, and "Breakthrough Simplicity" are trademarks or registered trademarks of Skyworks Solutions, Inc., in the United States and other countries. Third-party brands and names are for identification purposes only, and are the property of their respective owners. Additional information, including relevant terms and conditions, posted at www.skyworksinc.com, are incorporated by reference.





Общество с ограниченной ответственностью «МосЧип» ИНН 7719860671 / КПП 771901001 Адрес: 105318, г.Москва, ул.Щербаковская д.З, офис 1107

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

http://moschip.ru/get-element

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж: moschip.ru moschip.ru_4

moschip.ru_6 moschip.ru_9